Slab operation at Kyushu and development of one wire function for DIFs

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Yu Miura (Kyushu University) Jean-Claude Brient, Vincent Boudry, Vladislav Balagura, Date 19/Feb/2018, ILD ECAL pre -meeting





Agenda

✓ Slab operation at Kyushu

✓ Development of one wire function for DIFs









Agenda

✓ <u>Slab operation at Kyushu</u>

✓ Development of one wire function for DIFs









Motivation

✓ We evaluate SLABs used at DESY more than at test beam(6/2017@DESY) We prepare environment to

evaluate performance of new SLABs which will be produced and introduced in **Kyushu university next April**

 We want to use the new SLABs for next test beam at DESY









Setup

✓ Supply 100 V to silicon ✓ Co57 radiate gamma radiation of 136 keV (12.2 %) and 122 keV (87.65 $% \left(\frac{1}{2} \right) = \left(\frac{1}{2} \right) \left(\frac{1}{2}$

See detector from this angle



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52.5 mm





Result



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charge_hiGain[13][0][5]

charge_hiGain[13][0][5] {gain_hit_high[13][0][5]==1 &&badbcid[13][0]==0 && charge_hiGain[13][0][5]>0}



This position of histogram is red point of hit map.

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Analysis

✓ Data selection Select SCAs with more than 2000 hits ✓ **Position of pedestal and peak of 122 keV** We used fitted mean of Gaussian for calibration



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C.

Analysis

We can see Compton edge, but can't see peak of 136 keV ✓ There is histogram which is seen like peak of 136 keV Calibration is not good





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Agenda

✓ Slab operation at Kyushu

✓ <u>Development of one wire function for DIFs</u>









Motivation

✓ <u>Motivation</u>

In the future, a lot of detectors will be produced and installed in ILD

 Detect mis-order of detectors caused by mistakes of connection etc... —> Introducing unique ID

Confirm condition of devices

 Rise in temperature on SLABs —>Monitoring temperature of substrate

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June/2017 @DESY





DS2438

✓ We use DS2438 to introduce unique ID and monitor temperature of substrate. ✓ DS2438 requires only one port pin for communication ✓ DS2438 have 64 bits of unique ID and sensor which can measure temperature ✓ Operating range is -40 °C to +85 °C

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Picture of DS2438





Mount DS2438 on the SLAB

DS2438 have mounted on the SLAB Rewrite the FPGA for using DS2438



Zoom

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Detector TB@DESY June/2017

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Development of one wire for DIFs

✓ We use one wire to communicate DS2438 One wire requires serial communication ✓ Advantage of one wire is that it requires less space ✓ Disadvantage of one wire is that communication speed is slow Now, we have code of reading measured temperature and unique ID ✓ But, the code is not included in code of DAQ We want to include the code of one wire to the code of DAQ



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3.3 V **5.1 kΩ**

DQ: one wire





Protocol of reading unique ID during starting SMB and DIF (1)



ID

Send a signal to get information of unique ID in ROM from FPGA to DS2438 via DQ



This object "ID" is information of unique ID

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FPGA

DS2438









Protocol of reading unique ID during starting SMB and DIF (2)



ID





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FPGA

DS2438

DQ RAM ROM ID D Send the information from DS to FPGA via DQ





Protocol of reading unique ID during starting SMB and DIF (3)





The information is written in RAM

ID

This object "ID" is information of unique ID

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FPGA

DS2438

RAM D

DQ

ROM D

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Protocol of reading measured temperature during starting SMB and DIF











Protocol of reading unique ID and measured temperature (1)

PC

DS2438 FPGA Send a signal of reading unique ID or measured temperature from PC to FPGA **HDMI** DQ RAM ROM Info Info



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Info

This object "Info" is information of unique ID and measured temperature







Protocol of reading unique ID and measured temperature (2)



Send the information form FPGA to PC

HDMI

Info

Info

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FPGA

DS2438



This object "Info" is information of unique ID and measured temperature







Protocol of reading unique ID and measured temperature (2)





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FPGA

DS2438







Current condition

✓ We could prepare for environment to study about development of one wire function for DIFS

We can get unique ID on the simulation

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Setup PC









Summary and prospect

✓ <u>Slab operation</u> ✓ We could operate SLAB and acquire data of Co57 We can't get peak of 136 keV because we think calibration is not good ✓ <u>Development of one wire for DIFs</u> We are introducing into unique ID and system of measuring temperature

 We think that study of one wire will be finished until next JPS (22/Mar/2018)





